

# PRELIMINARY

Notice: This is not a final specification.  
Some parametric limits are subject to change.

MITSUBISHI SEMICONDUCTOR <GaAs FET>

# MGFC42V5964A

5.9~6.4GHz BAND 16W INTERNALLY MATCHED GaAs FET

## DESCRIPTION

The MGFC42V5964A is an internally impedance-matched GaAs power FET especially designed for use in 5.9 ~ 6.4 GHz band amplifiers. The hermetically sealed metal-ceramic package guarantees high reliability.

## FEATURES

- Class A operation
- Internally matched to  $50\Omega$  system
- High output power  
 $P_{1dB} = 18W$  (TYP) @ 5.9 ~ 6.4 GHz
- High power gain  
 $G_{LP} = 9$  dB (TYP) @ 5.9 ~ 6.4 GHz
- High power added efficiency  
 $\eta_{add} = 33\%$  (TYP) @ 5.9 ~ 6.4 GHz,  $P_{1dB}$
- Hermetically sealed metal-ceramic package
- Low distortion [Item: -51]  
 $IM_3 = -45$  dBc (TYP) @  $P_o = 31$  (dBm) S.C.L.
- Low thermal resistance  $R_{th(ch-c)} \leq 1.6$  ( $^{\circ}\text{C}/\text{W}$ )

## APPLICATION

Item -01: 5.9 ~ 6.4 GHz band power amplifier

Item -51: Digital radio communication

## QUALITY GRADE

- IG

## ABSOLUTE MAXIMUM RATINGS ( $T_a = 25^{\circ}\text{C}$ )

Symbol	Parameter	Ratings	Unit
$V_{GDO}$	Gate to drain voltage	-15	V
$V_{GSO}$	Gate to source voltage	-15	V
$I_D$	Drain current	12	A
$I_{GR}$	Reverse gate current	-40	mA
$I_{GF}$	Forward gate current	84	mA
$P_T$	Total power dissipation *1	93.7	W
$T_{ch}$	Channel temperature	175	$^{\circ}\text{C}$
$T_{stg}$	Storage temperature	-65 ~ +175	$^{\circ}\text{C}$

\*1:  $T_c = 25^{\circ}\text{C}$

## ELECTRICAL CHARACTERISTICS ( $T_a = 25^{\circ}\text{C}$ )

Symbol	Parameter	Test conditions	Limits			Unit
			Min	Typ	Max	
$I_{DSS}$	Saturated drain current	$V_{DS}=3\text{V}$ , $V_{GS}=0\text{V}$	—	9	12	A
$g_m$	Transconductance	$V_{DS}=3\text{V}$ , $I_D=4.4\text{A}$	—	4	—	S
$V_{GS(off)}$	Gate to source cut-off voltage	$V_{DS}=3\text{V}$ , $I_D=80\text{mA}$	-2	-3	-4	V
$P_{1dB}$	Output power at 1dB gain compression		41.5	42.5	—	dBm
$G_{LP}$	Linear power gain		8	9	—	dB
$I_D$	Drain current	$V_{DS}=10\text{V}$ , $I_D=4.5\text{A}$ , $f=5.9\sim6.4\text{GHz}$	—	4.5	—	A
$\eta_{add}$	Power added efficiency		—	33	—	%
$IM_3$	3rd order IM distortion *1		-42	-45	—	dBc
$R_{th(ch-c)}$	Thermal resistance *2	$\Delta V_f$ method	—	—	1.6	$^{\circ}\text{C}/\text{W}$

\*1: Item-51, 2-tone test  $P_o = 31$  dBm Single Carrier Level  $f = 6.4$  GHz  $\Delta f = 10$  MHz. \*2: Channel to case

NOV. '97

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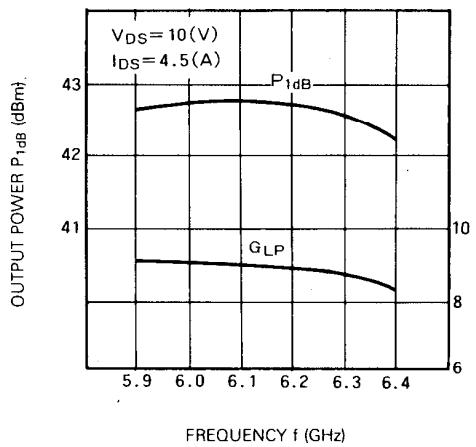
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**MGFC42V5964A**

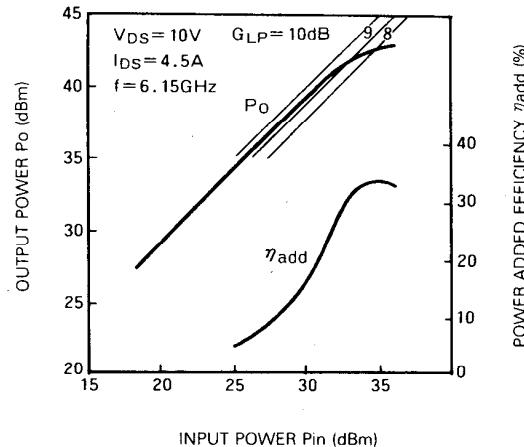
**5.9~6.4GHz BAND 16W INTERNALLY MATCHED GaAs FET**

**TYPICAL CHARACTERISTICS** ( $T_a = 25^\circ\text{C}$ )

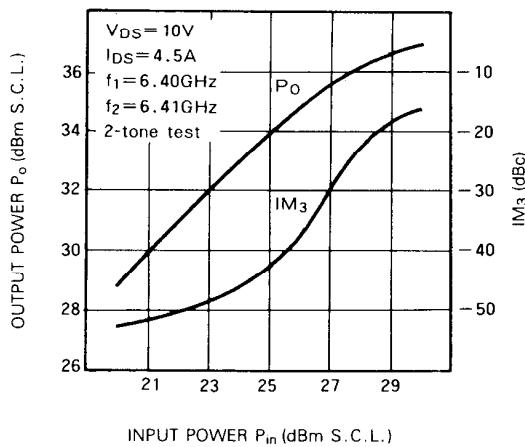
$P_{1\text{dB}}, G_{LP}$  vs.  $f$



$P_o, \eta_{add}$  vs.  $P_{in}$



$P_o, IM_3$  vs.  $P_{in}$



**S PARAMETERS** ( $T_a = 25^\circ\text{C}$ ,  $V_{DS} = 10\text{ V}$ ,  $I_{DS} = 4.5\text{ A}$ )

f (GHz)	S Parameters (TYP.)							
	S <sub>11</sub>		S <sub>21</sub>		S <sub>12</sub>		S <sub>22</sub>	
	Magn.	Angle (deg.)	Magn.	Angle (deg.)	Magn.	Angle (deg.)	Magn.	Angle (deg.)
5.9	0.36	82	2.99	-74	0.071	-133	0.26	80
6.0	0.35	56	2.95	-91	0.071	-151	0.32	72
6.1	0.35	34	2.91	-108	0.072	-167	0.35	65
6.2	0.35	14	2.88	-124	0.078	177	0.37	58
6.3	0.34	-4	2.81	-140	0.079	161	0.41	53
6.4	0.33	-23	2.72	-157	0.079	146	0.43	48

NOV. '97